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Vishay/Siliconix SUM75N15-18P-E3

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SUM75N15-18P

Vishay Siliconix

N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY			
V _{(BR)DSS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)
150	0.018 at V _{GS} = 10 V	75 ^d	64

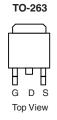
FEATURES

- TrenchFET® Power MOSFET
- 100 % R_q and UIS Tested

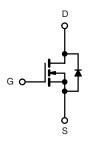


APPLICATIONS

- Primary Side Switch
- · Power Supplies



Ordering Information: SUM75N15-18P-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	150	V		
Gate-Source Voltage		V _{GS}	± 20	7 v	
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 25 °C		75 ^d	A	
Continuous Diam Guiterit (1) = 150 G)	T _C = 70 °C	- I _D	70		
Pulsed Drain Current		I _{DM}	180		
Avalanche Current		I _{AS}	50]	
Single Avalanche Energy ^a	e Energy ^a L = 0.1 mH		125	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	В	312.5 ^b	w	
	T _A = 25 °C ^c	P _D	3.12		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.4	- 'C/W	

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).
- d. Package limited.

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Datasheet of SUM75N15-18P-E3 - MOSFET N-CH 150V 75A D2PAK

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	•			•		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	150			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 125 °C			50	
		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 150 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
Drain-Source On-State Resistance ^a	В	V _{GS} = 10 V, I _D = 20 A		0.0148	0.018	Ω
	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.0296	0.036	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		55		S
Dynamic ^b	<u>'</u>			<u>'</u>		
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 75 V, f = 1 MHz		4180		pF
Output Capacitance	C _{oss}			235		
Reverse Transfer Capacitance	C _{rss}			83		
Total Gate Charge ^c	Qg			64	100	nC
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		23		
Gate-Drain Charge ^c	Q _{gd}			16		
Gate Resistance	R _g	f = 1 MHz		2.1	4.2	Ω
Turn-On Delay Time ^c	t _{d(on)}			15	25	
Rise Time ^c	t _r	V_{DD} = 75 V, R_L = 0.88 Ω		10	15	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		25	40	
Fall Time ^c	t _f			8	15	
Source-Drain Diode Ratings and Cha	aracteristics 7	C = 25 °C ^b				
Continuous Current	Is				75	
Pulsed Current	I _{SM}				180	- A
Forward Voltage ^a	V _{SD}	I _F = 30 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		8	12	Α
Reverse Recovery Charge	Q _{rr}	,		520	1200	nC

Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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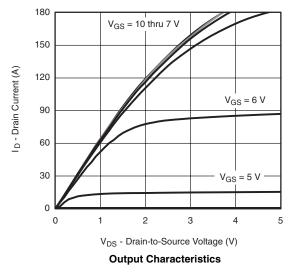


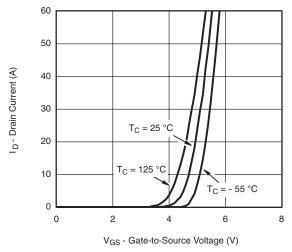


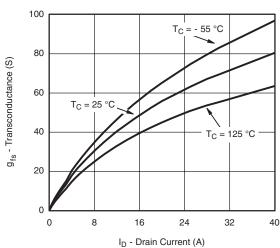
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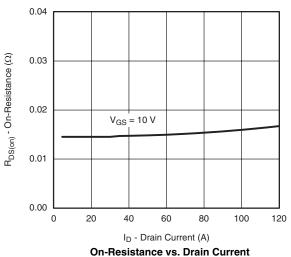
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



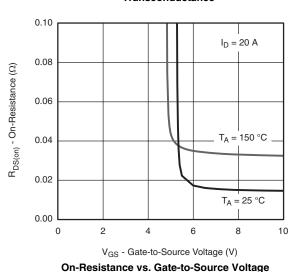


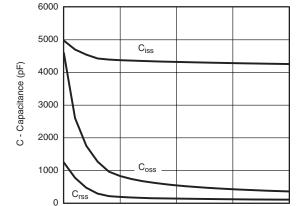


Transfer Characteristics



Transconductance





0

10

20 V_{DS} - Drain-to-Source Voltage (V)

Capacitance

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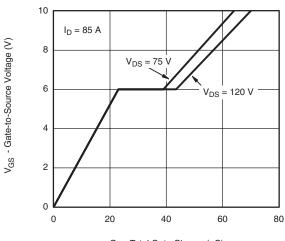


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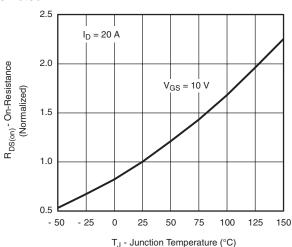
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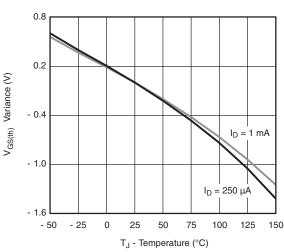




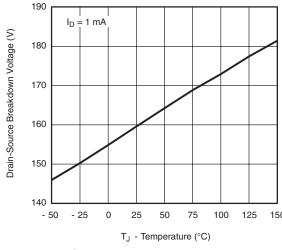




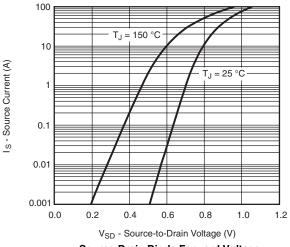
On-Resistance vs. Junction Temperature



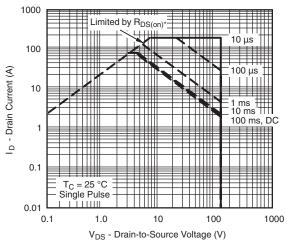
Threshold Voltage



Drain-Source Breakdown vs. Junction Temperature



Source-Drain Diode Forward Voltage



* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified **Safe Operating Area, Junction-to-Case**

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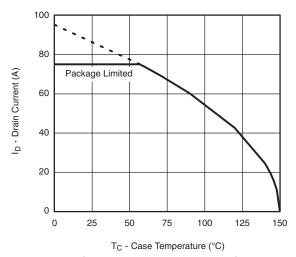
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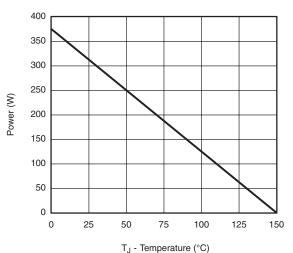


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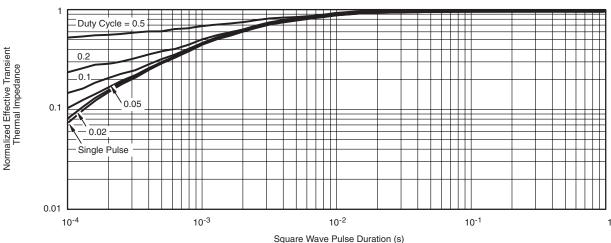
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Current Derating*, Junction-to-Case

Power Derating*, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?69995.

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^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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